

# **UTC** UNISONIC TECHNOLOGIES CO., LTD

## 22N60

## 22A, 600V N-CHANNEL **POWER MOSFET**

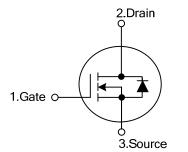
#### DESCRIPTION

As the SMPS MOSFET, the UTC 22N60 uses UTC's advanced technology to provide excellent R<sub>DS(ON)</sub>, low gate charge and operation with low gate voltages. This device is suitable for use as a load switch or in PWM applications.

#### **FEATURES**

- \*  $R_{DS(ON)}$  = 0.35 $\Omega$
- \* Ultra Low Gate Charge ( Typical 150 nC )
- \* Low Reverse Transfer Capacitance ( $C_{RSS}$  = Typical 36 pF)
- \* Fast Switching Capability
- \* Avalanche Energy Specified
- \* Improved dv/dt Capability, High Ruggedness

#### **SYMBOL**

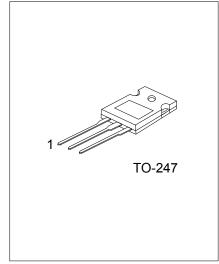


#### ORDERING INFORMATION

Ordering Number		Daakaga	Pin Assignment			Deaking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
22N60L-T47-T	22N60G-T47-T	TO-247	G	D	S	Tube	

22N60L- <u>T47-T</u> (1)Packing Type	(1) T: Tube
(2)Package Type	(2) T47: TO-247
(3)Lead Free	(3) G: Halogen Free, L: Lead Free

## **Power MOSFET**



#### ■ ABSOLUTE MAXIMUM RATINGS (T<sub>c</sub> =25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V <sub>DSS</sub>	600	V	
Gate-Source Voltage		V <sub>GSS</sub>	±30	V	
Avalanche Current		I <sub>AR</sub>	22	А	
Continuous Drain Current		I <sub>D</sub>	22	А	
Pulsed Drain Current (Note 1)		I <sub>DM</sub>	88	А	
Avalanche Energy	Single Pulsed	E <sub>AS</sub>	380	mJ	
	Repetitive	E <sub>AR</sub>	37	mJ	
Peak Diode Recovery dv/dt (Note 3)		dv/dt	18	V/ns	
Power Dissipation		PD	370	W	
Junction Temperature	9	TJ	150	°C	
Operating Temperatu	ire	Topr	-55 ~ +150	°C	
Storage Temperature		T <sub>STG</sub>	-55 ~ +150	°C	

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

#### THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	θ <sub>JA</sub>	40	°C /W
Junction to Case	θις	0.34	°C /W



#### ■ ELECTRICAL CHARACTERISTICS (T<sub>J</sub> =25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250µA	600			V	
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =600V, V <sub>GS</sub> =0V			50	μA	
Gate- Source Leakage Current	I <sub>GSS</sub>	$V_{DS}=0V, V_{GS}=\pm 30V$			±100	nA	
Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_{J}$	I <sub>D</sub> =1mA,Referenced to 25°C		0.30		V/°C	
ON CHARACTERISTICS							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250µA	2.0		4.0	V	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =13A (Note 4)		0.26	0.35	Ω	
DYNAMIC PARAMETERS	_	_					
Input Capacitance	C <sub>ISS</sub>			3570		рF	
Output Capacitance	C <sub>OSS</sub>	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1.0MHz		350		pF	
Reverse Transfer Capacitance	C <sub>RSS</sub>			36		рF	
SWITCHING PARAMETERS	_	_					
Turn-ON Delay Time	t <sub>D(ON)</sub>	$V_{DD}$ =300V, I <sub>D</sub> =22A, R <sub>G</sub> =6.2Ω $V_{GS}$ =10V (Note 4)		26		ns	
Turn-ON Rise Time	t <sub>R</sub>			99		ns	
Turn-OFF Delay Time	t <sub>D(OFF)</sub>			48		ns	
Turn-OFF Fall-Time	t <sub>F</sub>			37		ns	
Total Gate Charge	$Q_G$				150	nC	
Gate Source Charge	Q <sub>GS</sub>	V <sub>DS</sub> =480V, V <sub>GS</sub> =10V,			45	nC	
Gate Drain Charge	$Q_{GD}$	-I <sub>D</sub> =22A (Note 4)			76	nC	
DRAIN-SOURCE DIODE CHARACTERISTICS		IUM RATINGS					
Drain-Source Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =22A			1.5	V	
Continuous Source Current (Body Diode)	ls	(Note 1)			22	А	
Pulsed Source Current (Body Diode)	I <sub>SM</sub>				88	А	
Reverse Recovery Time	t <sub>rr</sub>	I <sub>S</sub> =22A, di/dt=100A/µs		590	890	ns	
Reverse Recovery Charge	Q <sub>RR</sub>	(Note 4)		7.2	11	μC	

Notes: 1. Repetitive rating; pulse width limited by max. junction temperature.

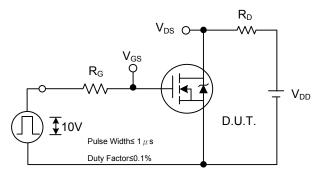
2.  $T_J$  = 25°C, L = 1.5mH,  $R_G$  =25 $\Omega$ ,  $I_{AS}$  = 22A

3.  $I_{SD} \leq 22A$ , di/dt  $\leq$ 540A/µs,  $V_{DD} \leq V_{(BR)DSS}$ ,  $T_J \leq$ 150°C.

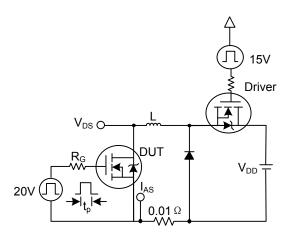
4. Pulse Width  $\leq$  300 s, Duty Cycle  $\leq$  2%.

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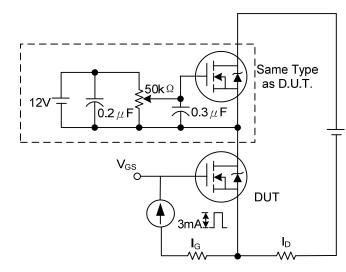
## TEST CIRCUITS



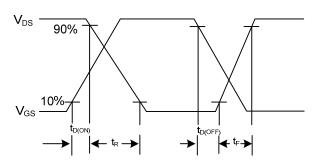
Switching Test Circuit



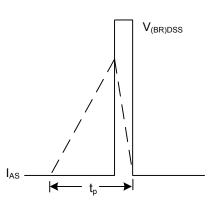
**Unclamped Inductive Switching Test Circuit** 



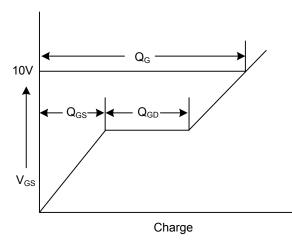
Gate Charge Test Circuit



Switching Waveforms



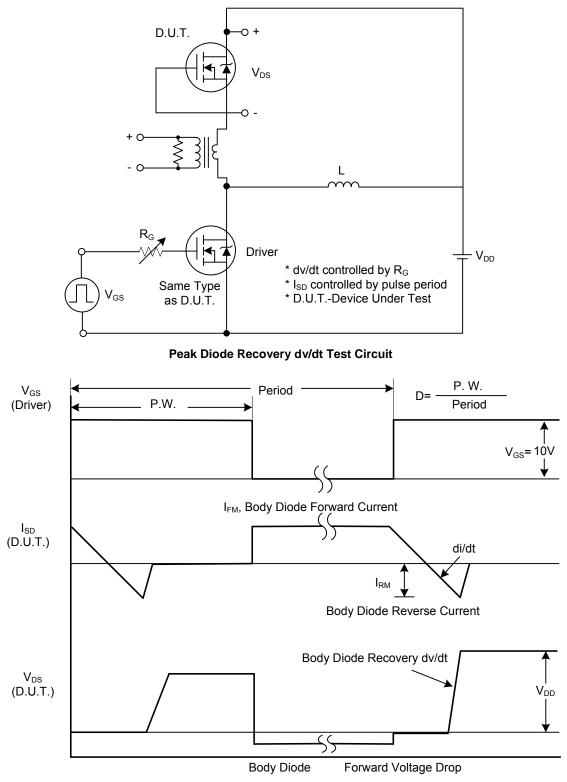
### Unclamped Inductive Switching Waveforms







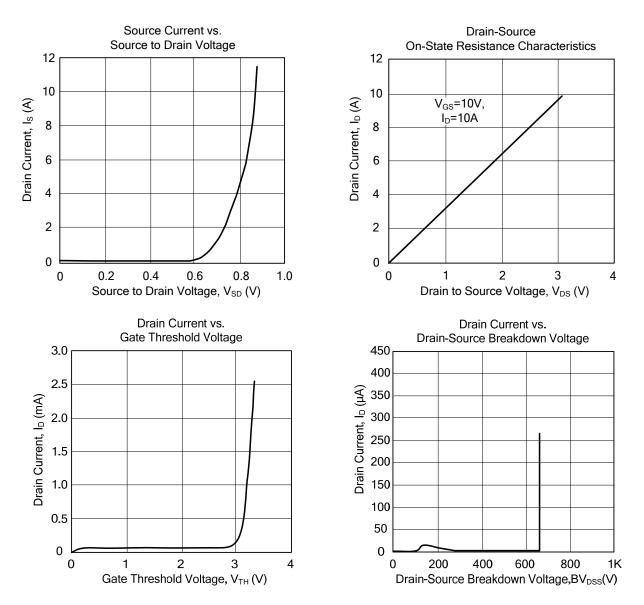
## ■ TEST CIRCUITS(Cont.)





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#### TYPICAL CHARACTERISTICS



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